

Supplementary Materials: Thermal Stability of Nanocrystalline Gradient Inconel 718 Alloy

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Supplementary Materials

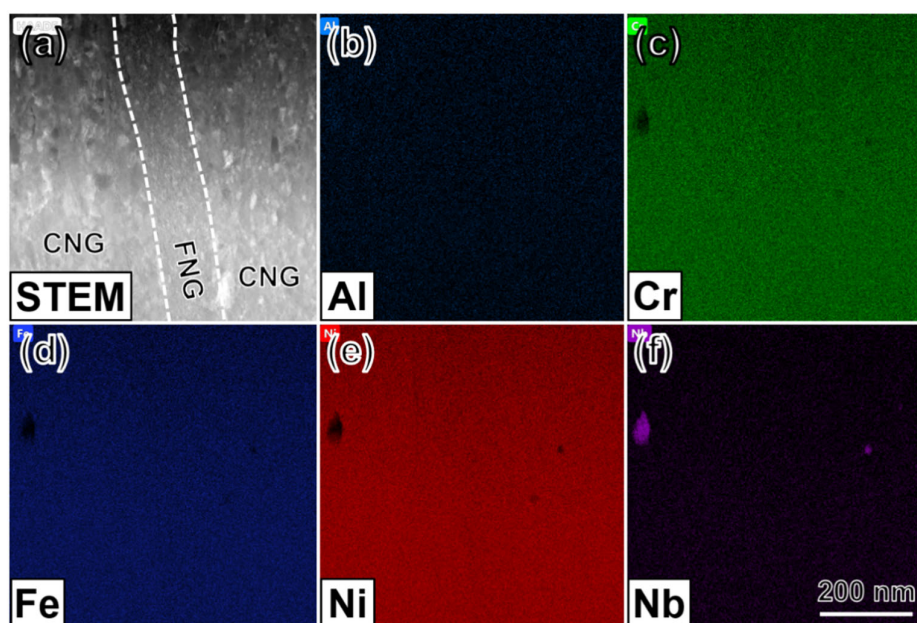


Figure S1. (a) STEM image and the corresponding (b–f) EDS maps of the NG layer of the as-processed IN718 alloy.

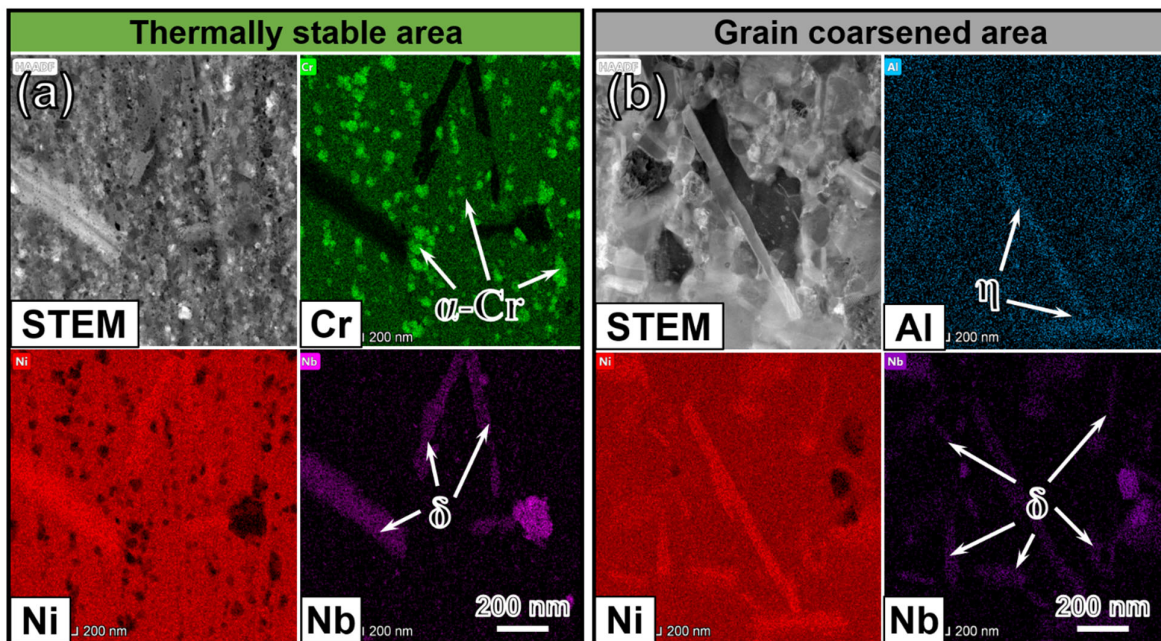


Figure S2. STEM image and EDS maps of (a) thermally stable area and (b) grain coarsened areas of NG IN718 specimen after annealing at 700 °C for 24 h.